

EMI Ferrite Bead



BBUP Series



Overview

EMI ferrite beads are made of ferrite material, which can block high-frequency noise while allowing required signals to pass through, providing high impedance and noise attenuation to improve signal integrity/efficiency and reduce power loss.

Benefits

1. For Power Line
2. Compliance with EMI regulations.
3. Reduced power loss and improved system efficiency
4. Operating temperature range: -55 ~ +125°C
5. Improved signal integrity

Applications

1. Wearable device
2. Industrial
3. Communications
4. Consumer Electronics

Product Information

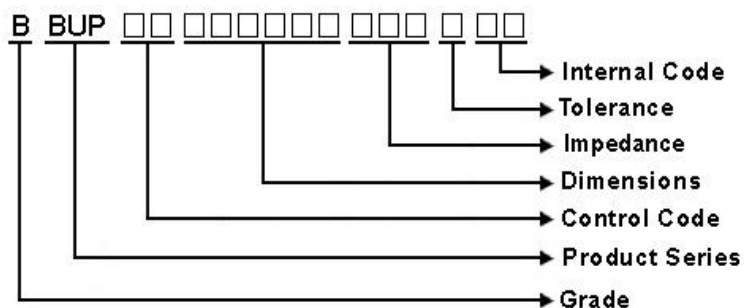
Series	Size Code (JIS/EIA)	Impedance (Ω)
BBUP	1005/0402	10 ~ 470
	1608/0603	
	2012/0805	
	3216/1206	
	4532/1812	



BBUP00160805 Series Specification

1 Scope: This specification applies to MULTILAYER FERRITE CHIP BEADS

2 Part Numbering:



3 Rating:

Operating Temperature: - 5 5 °C ~ 1 2 5 °C(Including self - temperature rise)

Storage Temperature: - 5 5 °C ~ 1 2 5 °C(after PCB)

- 5 °C~ 4 0 °C,Humidity 4 0 %~ 7 0 %(before PCB)

4 Marking:

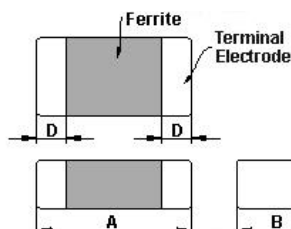
No Marking

5 Standard Testing Condition

	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35°C)	20 to 30°C
Humidity	Ordinary Humidity(25 to 85% RH)	50 to 80 %RH

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6 Configuration and Dimensions:



Dimensions in mm

TYPE	160805
A	1.6±0.15
B	0.8±0.15
C	0.5±0.15
D	0.3±0.20

Net Weight (grms)

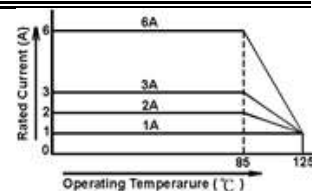
Size Code	Net Weight (grms)
160805	0.00352

7 Electrical Characteristics:

Part No.	Impedance (Ω)	Test Freq.	RDC (Ω)Max.	Rated Current (mA)Max.
BBUP00160805260□00	26	100 MHz, 200 mV	0.007	6000
BBUP00160805300□00	30	100 MHz, 200 mV	0.007	6000
BBUP00160805600□00	60	100 MHz, 200 mV	0.02	4000
BBUP00160805700□00	70	100 MHz, 200 mV	0.02	4000
BBUP00160805101□00	100	100 MHz, 200 mV	0.025	3000
BBUP00160805121□00	120	100 MHz, 200 mV	0.025	3000
BBUP00160805221□00	220	100 MHz, 200 mV	0.04	2500
BBUP00160805331□00	330	100 MHz, 200 mV	0.07	1500

NOTE: □-tolerance Y=±25% / T=±30%

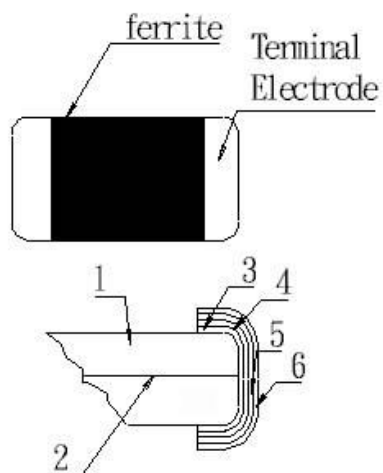
- Operating temperature range - 5 5 °C ~ 1 2 5 °C(Including self - temperature rise)
- Rate Current : Applied the current to coils, the temperature rise shall not be more than 30°C
- As for BBUP type. Rated Current is derated as right figure depending on the operating temperature.



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8.1 Construction:



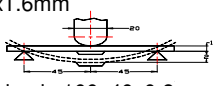
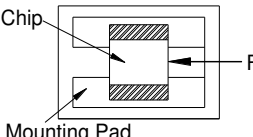
8.2 Material List:

No	Part	Material
1	Ferrite Substance	NiO-CuO-ZnO-Ferrite
2	Silver electrode	Ag
3	Silver electrode	Ag
4	Cu plating	Cu
5	Ni plating	Ni
6	Sn plating	Sn

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9 Reliability Of Ferrite Multilayer Chip Bead

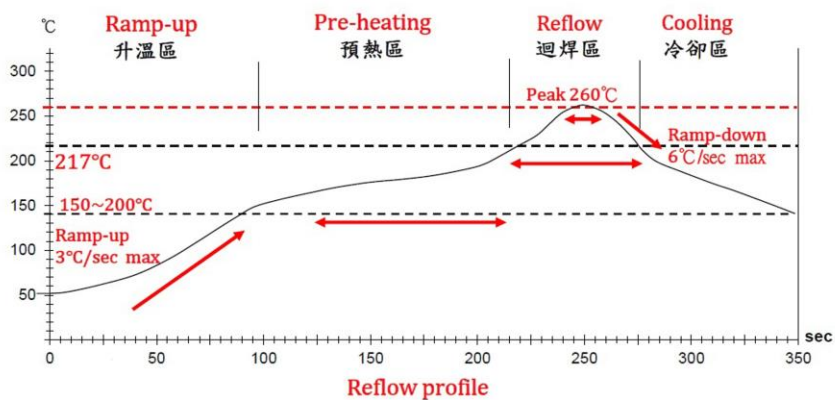
1-1.Mechanical Performance

No	Item	Specification	Test Method
1-1-1	Flexure Strength	The forces applied on the right conditions must not damage the terminal electrode and the ferrite	Test device shall be soldered on the substrate Substrate Dimension: 100x40x1.6mm Deflection: 2.0mm Keeping Time: 30sec  *For 100505, substrate dimension is 100x40x0.8mm
1-1-2	Vibration		Test device shall be soldered on the substrate Oscillation Frequency: 10 to 55 to 10Hz for 1min Amplitude: 1.5mm Time: 2hrs for each axis (X, Y & Z), total 6hrs
1-1-3	Resistance to Soldering Heat	Appearance: No damage More than 75% of the terminal electrode should be covered with solder. Impedance : within $\pm 30\%$ of initial value	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 260 ± 5 °C Immersion Time: 10 ± 1 sec
1-1-4	Solder ability	The electrodes shall be at least 95% covered with new solder coating	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 245 ± 5 °C (Pb-Free) Immersion Time: 4 ± 1 sec
1-1-5	Terminal Strength Test	No split termination  Chip Mounting Pad	Test device shall be soldered on the substrate, then apply a force in the direction of the arrow. Force : 5N Keeping Time: 10 ± 1 sec

1-2.Environmental Performance

1. Environmental Performance					
No	Item	Specification	Test Method		
1-2-1	Temperature Cycle	Appearance: No damage Impedance: within±30% of initial value	One cycle:		
			Step	Temperature (°C)	Time (min)
			1	-55±3	30
			2	25±2	3
			3	125±3	30
			4	25±2	3
Total: 100cycles					
Measured after exposure in the room condition for 24hrs					
1-2-2	Humidity Resistance		Temperature: 40±2℃ Relative Humidity: 90 ~ 95% / Time: 1000hrs Measured after exposure in the room condition for 24hrs		
1-2-3	High Temperature Resistance		Temperature: 125±3℃ / Relative Humidity: 0% Applied Current: Rated Current /Time: 1000hrs Measured after exposure in the room condition for 24hrs		
1-2-4	Low Temperature Resistance		Temperature: -55±3℃ Relative Humidity: 0% / Time: 1000hrs Measured after exposure in the room condition for 24hrs		

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Lead-Free(LF)標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升温區 Ramp-up	預熱區 Pre-heating	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp.scope	R.T ~ 150°C	150°C ~ 200°C	Above 217°C	260±5°C	Peak Temp.~150°C
標準時間 Time spec.	-	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	-
實際時間 Time result	-	75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	-

NOTE :

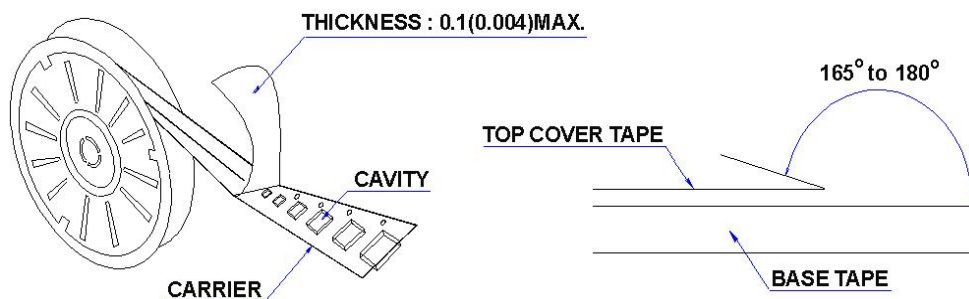
1. Re-flow possible times : within 2 times
2. Nitrogen adopted is recommended while in re-flow
3. Products can only be soldered with reflow

BBUP00160805 Series Specification

11 Packaging:

11.1 Packaging -Cover Tape

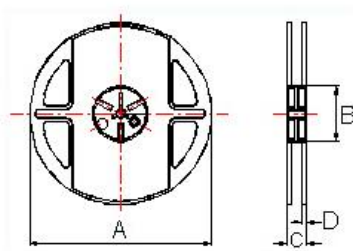
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



11.2 Packaging Quantity

TYPE	PCS/REEL
100505	10000
160805	10000
160808	4000
201209	4000

11.3 Reel Dimensions



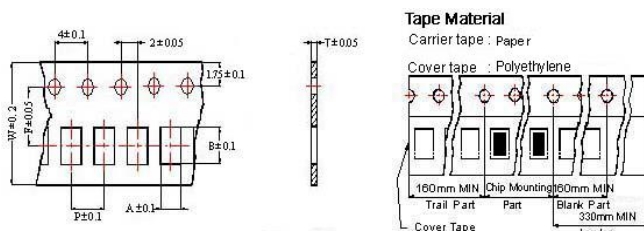
Dimensions in mm

TYPE	A	B	C	D
100505	178	60	12	1.5
160805	178	60	12	1.5
160808	178	60	12	1.5
201209	178	60	12	1.5

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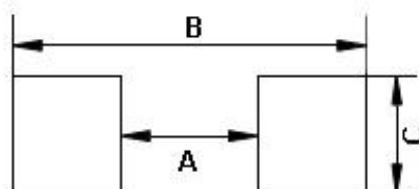
11 Packaging:

11.4 Tape Dimensions in mm



TYPE	A	B	T	W	P	F
100505	0.62	1.12	0.60	8	2	3.5
160805	1.05	1.85	0.60	8	2	3.5
160808	1.05	1.85	0.95	8	4	3.5
201209	1.50	2.30	0.97	8	4	3.5

12 Recommended Land Pattern:



Dimensions in mm

TYPE	A	B	C
160805	0.7 ~ 0.8	1.8 ~ 2.0	0.6 ~ 0.8

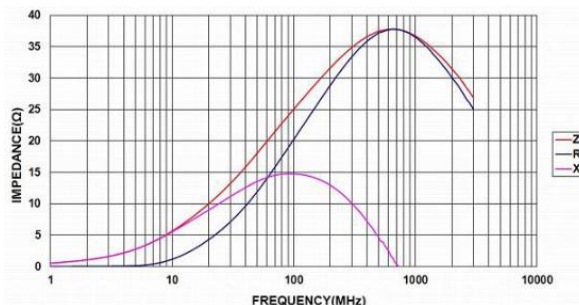
13 Note:

1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
2. Do not knock nor drop.
3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose, under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
5. The moisture sensitivity level (MSL) of products is classified as level 1.

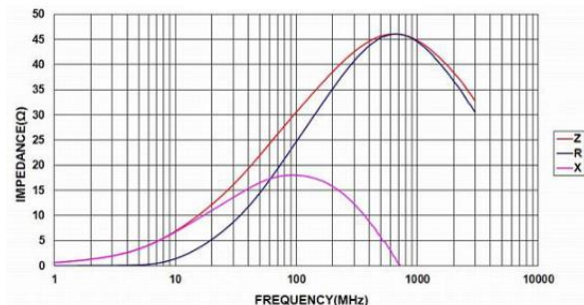
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14 Graph:

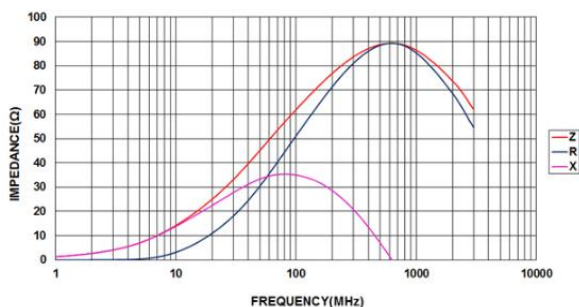
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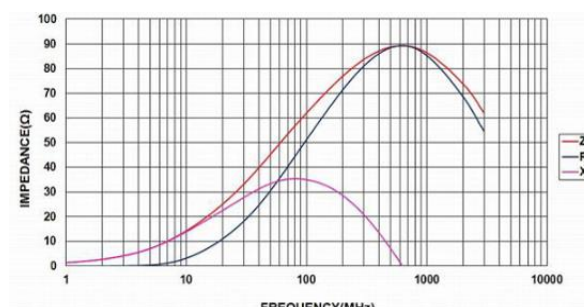
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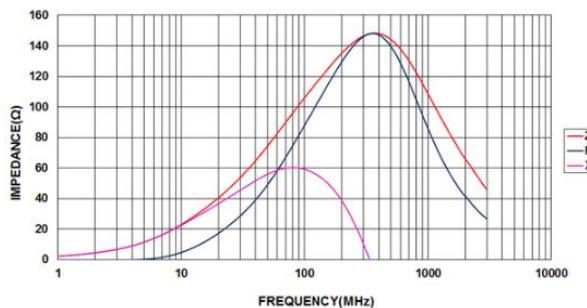
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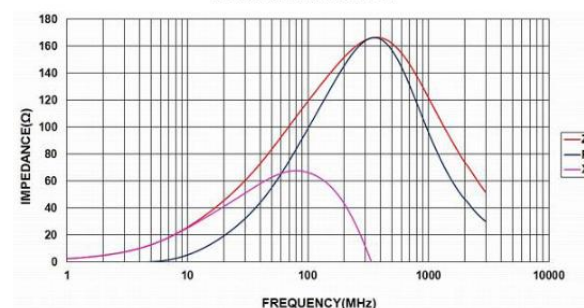
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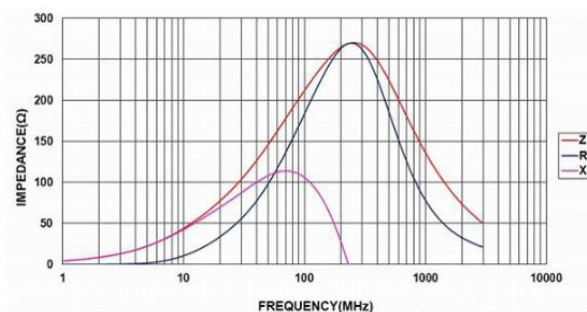
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